

NASA Low Outgassing Compliant Epoxies

Epoxies, Etc. offers a wide range of products that meet NASA's low outgassing requirements. These requirements NASA outlines include having a total mass lost (TML) of less than 1% and collected volatile condensable materials (CVCM) of less than 0.1%.

EPOXIES, ETC. PRODUCT NUMBER

DESCRIPTION

[20-3652 with Cat.190](#)

Room temperature curing epoxy resin that displays outstanding adhesion properties

[50-3122](#)

One component thermally conductive and electrically insulating epoxy adhesive

[50-3150FR with Cat.190](#)

UL listed 94 V-0 epoxy that cures at room temperature. Ideal in applications that require high thermal conductivity and flame retardancy.

[50-3185RNC with Cat.30](#)

Thermally conductive potting & encapsulating resin, with high operating temperatures. 0.00% CVCM

[50-3185RNC with Cat.190](#)

Thermally conductive potting & encapsulating resin that cures at room temperature.

[70-3812RNC](#)

Aluminum filled epoxy with high thermal transfer properties, ideal for heat sink and fin bonding applications. Cures at room temperature.

IMPORTANT:

EPOXIES, ETC. MAKES NO EXPRESS OR IMPLIED WARRANTIES OR MERCHANTABILITY, FITNESS OR OTHERWISE WITH RESPECT TO ITS PRODUCTS. The information in this brochure is based on data obtained by our own research and is considered reliable. However, no warranty is expressed or implied regarding the accuracy of these data, the results to be obtained from the use thereof, or that any such use will not infringe any patent. The properties given are typical values and are not intended for use in preparing specifications. This information is furnished upon the condition that the person receiving it shall make his own tests to determine the suitability thereof for his particular purpose.

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